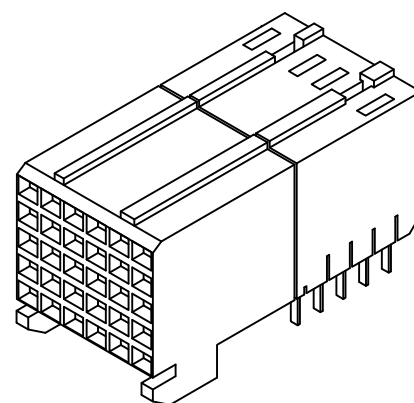
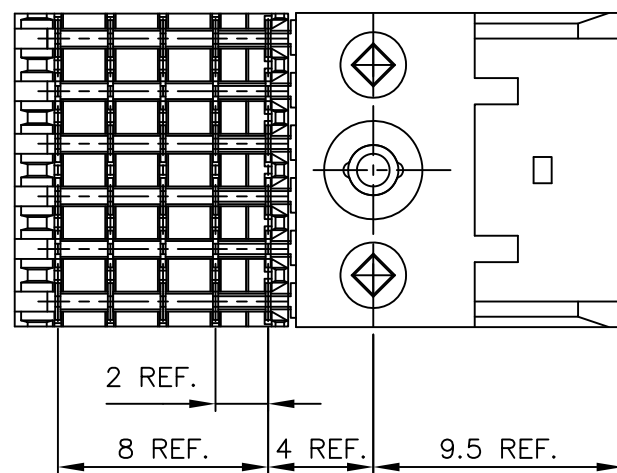
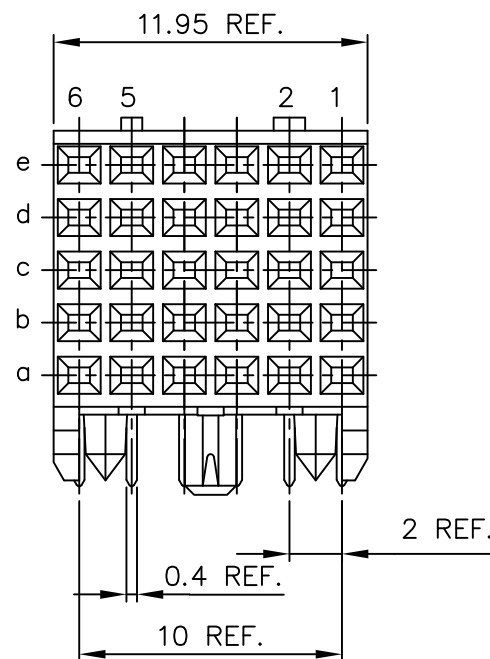
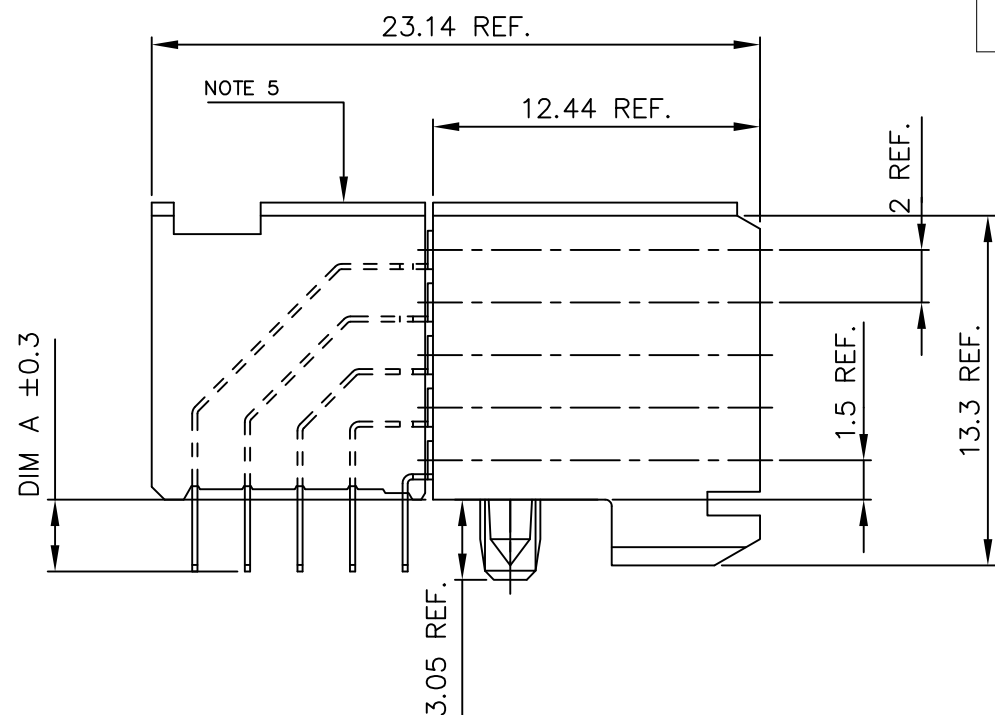


PCB BOARD VERSIONS			LOADING CONFIGURATION
PRODUCT NR:	PCB THICKNESS	DIM "A"	
85863-X02LF	1.6	2.90	FULLY LOADED
85863-X12LF	2.4	3.53	

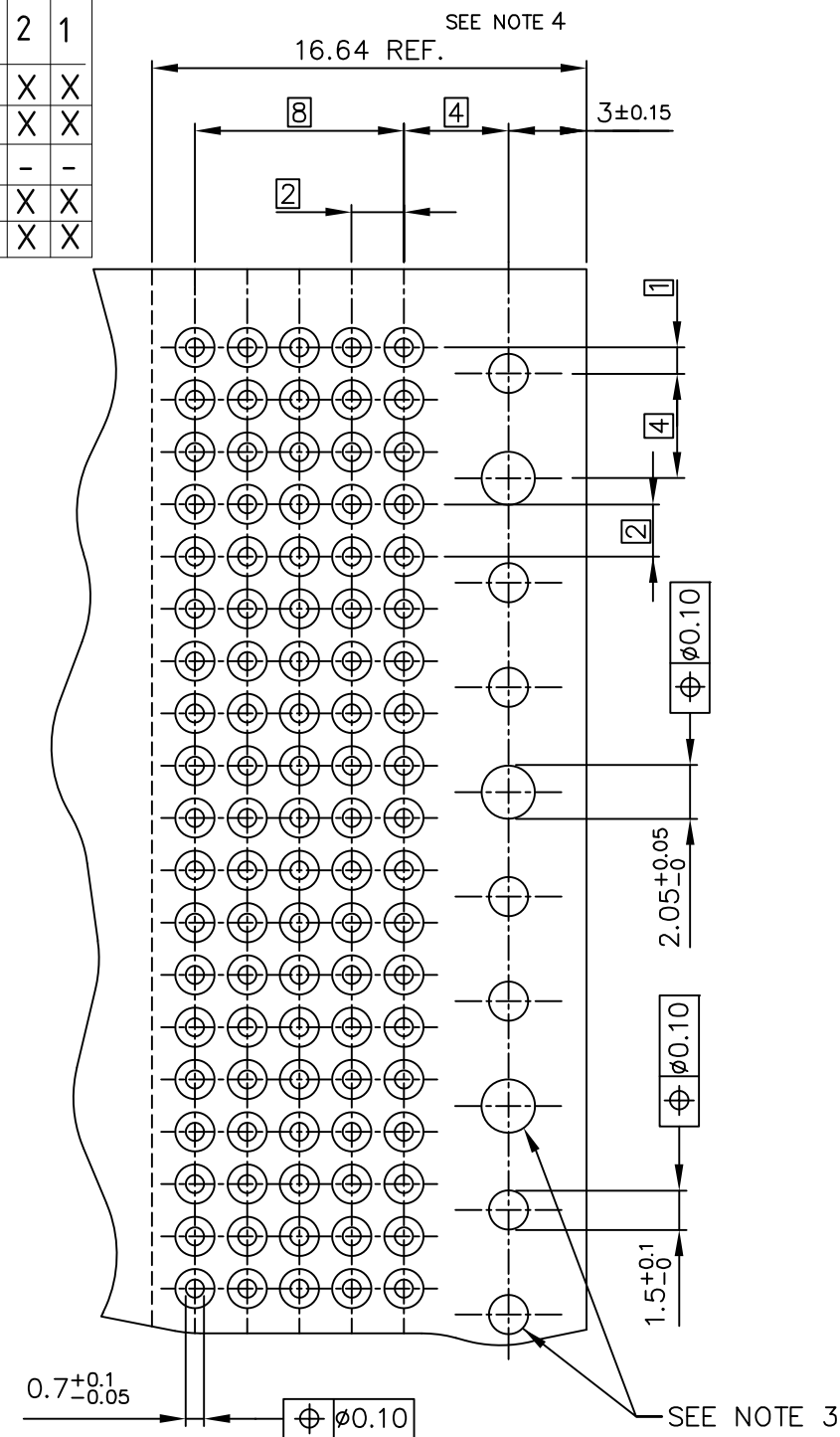
PRODUCT NUMBER	PCB THICKNESS	DIM "A"	ROW	6	5	4	3	2	1
85863-X03 LF	1.6	2.90	E	X	X	X	-	X	X
			D	X	X	X	-	X	X
			C	X	X	X	X	-	-
			B	X	X	X	-	X	X
			A	X	X	X	-	X	X

LOAD PATTERN	
X	LOADED
-	NOT LOADED

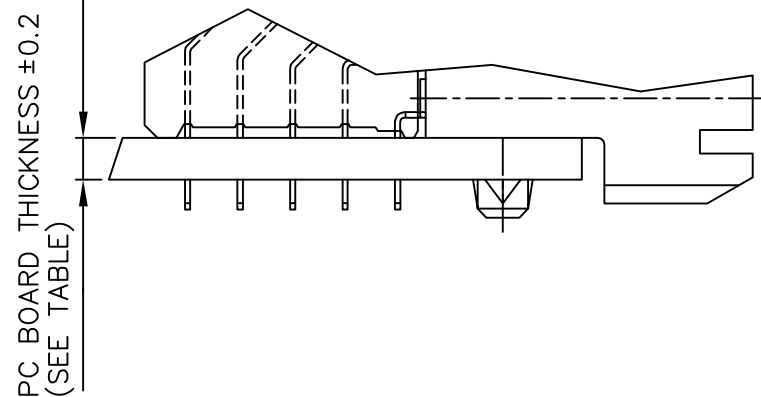


PART NUMBER : 85863-XYLFF

REFER NOTE-2



RECOMMENDED HOLE PATTERN, COMPONENT SIDE.



PC BOARD THICKNESS ±0.2 (SEE TABLE)

NOTES:

- MATERIAL : BODY : THERMOPLASTIC UL94-V0
: CONTACT : COPPER ALLOY.
- FOR PLATING PERFORMANCE REFER DRAWING # 10159408
- INDICATED HOLES ARE UNPLATED
- SET BACK FOR TAIL BLOCK
- TOP SURFACE OF PRESS BLOCK MAY EXTEND UP TO 0.4MM HIGHER THAN HOUSING. THIS MAY AFFECT THE TAIL LENGTH BEFORE APPLICATION TO A BOARD.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47- 0004
- A Δ SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.
- DIAMOND LOCATION PEG ARE ONLY EXISTED ON THE BOTH SIDES OF PRODUCT.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION.

mat'l. code		surface		tolerance		projection		product family	
ltr	ecn no	dr	date	ISO 1302	ISO 406	ISO 1101	mm	METRAL (fm)	
G	DG09-0068	CENH	2009-06-06	tolerances unless otherwise specified		0±0.3	mm	title	
H	DG-012848	QINDF	2012-06-09	angles	linear	0.00±0.13	mm	5 ROW RA STB SIGNAL	
J	ELX-1-39007	MINI	2020-11-18	0°±2°		0.00±0.050	scale	RECEPTACLE 12mm MOD PP	
		dr	R.VISSCHERS	1994-05-10					dwg no
		engr	ARUN	2020-11-18					sheet 1 of 1
		chr	ALEX BABU	2020-11-18					size
		appd	SANOJ	2020-11-18					A2
sheet index	revision	J						type Product Customer Drawing	
	sheet	1						85863	